

ARF1518



RF POWER MOSFET

N-CHANNEL ENHANCEMENT MODE

250V 750W 40MHz

The ARF1518 is an RF power transistor designed for very high power class C, D, and E applications in scientific, commercial, medical and industrial RF power generators and amplifiers up to 40MHz.

- Specified 250 Volt, 27.12 MHz Characteristics:
 - **Output Power = 750 Watts.**
 - Gain = 17dB (Class C)
 - Efficiency > 75%

- High Performance Power RF Package.
- Very High Breakdown for Improved Ruggedness.
- Low Thermal Resistance.
- Nitride Passivated Die for Improved Reliability.

| MAXIMUM RATINGS | All Ratings: $T_C = 25^{\circ}C$ unless otherwise specified. |
|-----------------|--|
|-----------------|--|

| Symbol | Parameter | ARF 1518 | UNIT |
|----------------------------------|--|------------|-------|
| V _{DSS} | Drain-Source Voltage | 1000 | Volts |
| I _D | Continuous Drain Current @ T _C = 25°C | 30 | Amps |
| V _{GS} | Gate-Source Voltage | ±30 | Volts |
| P _D | Total Device Dissipation @ T _C = 25°C | 1500 | Watts |
| T _J ,T _{STG} | Operating and Storage Junction Temperature Range | -55 to 200 | |
| T _L | Lead Temperature: 0.063" from Case for 10 Sec. | 300 | °C |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | | TYP | MAX | UNIT | |
|---------------------|--|------|-----|------|-------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 250 μA) | | | | Volts | |
| R _{DS(ON)} | On State Drain Voltage ① (I _{D(ON)} = 15A, V _{GS} = 10V) | | .4 | .6 | Ohms | |
| | Zero Gate Voltage Drain Current (V _{DS} = 1000V, V _{GS} = 0V) | | | 100 | μA | |
| DSS | Zero Gate Voltage Drain Current (V _{DS} = 800V, V _{GS} = 0V, T _C = 125°C) | | | 1000 | μΛ | |
| I _{GSS} | Gate-Source Leakage Current (V _{GS} = ±30V, V _{DS} = 0V) | | | ±400 | nA | |
| g _{fs} | Forward Transconductance (V _{DS} = 25V, I _D = 15A) | | 17 | | mhos | |
| Visolation | RMS Voltage (60Hz Sinewave from terminals to mounting surface for 1 minute) | 2500 | | | Volts | |
| V _{GS(TH)} | Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 50 \text{mA})$ | 3 | | 5 | Volts | |

THERMAL CHARACTERISTICS

| Symbol | Characteristic (per package unless otherwise noted) | | TYP | MAX | UNIT |
|-----------------|---|--|------|------|--------|
| $R_{\theta JC}$ | Junction to Case | | | 0.12 | 00/14/ |
| $R_{\theta CS}$ | Case to Sink (Use High Efficiency Thermal Joint Compound and Planar Heat Sink Surface.) | | 0.09 | | °C/W |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|------------------------------|-----------------------------|-----|------|------|------|
| C _{iss} | Input Capacitance | V _{GS} = 0V | | 5400 | 6500 | |
| C _{oss} | Output Capacitance | V _{DS} = 200V | | 300 | 400 | pF |
| C _{rss} | Reverse Transfer Capacitance | f = 1 MHz | | 125 | 160 | |
| t _{d(on)} | Turn-on Delay Time | V _{GS} = 15V | | 8 | | |
| t _r | Rise Time | V _{DD} = 500V | | 5 | | ns |
| t _{d(off)} | Turn-off Delay Time | I _D = 30A @ 25°C | | 25 | | 115 |
| t _f | Fall Time | $R_G = 1.6 \Omega$ | | 13 | | |

FUNCTIONAL CHARACTERISTICS

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|-----------------|------------------------------------|-------------------------------|--------------------------------|-----|-----|------|
| G _{PS} | Common Source Amplifier Power Gain | f = 27.12 MHz | 15 | 17 | | dB |
| η | Drain Efficiency | $V_{GS} = 0V$ $V_{DD} = 250V$ | 70 | 75 | | % |
| Ψ | Electrical Ruggedness VSWR 10:1 | P _{out} = 750W | No Degradation in Output Power | | | |

¹ Pulse Test: Pulse width < 380 µS, Duty Cycle < 2%.

APT Reserves the right to change, without notice, the specifications and information contained herein.

Table 1 - Typical Class AB Large Signal Impedance -- ARF1501

| F (MHz) | Z _{in} (Ω) | $Z_{OL}\left(\Omega\right)$ |
|---------|---------------------|-----------------------------|
| 2.0 | 10.6 -j 12.2 | 31 -j 4.7 |
| 13.5 | 0.5 - j 2.7 | 15.6 -j 16 |
| 27 | 0.22 -j 2.7 | 6.2 -j 12.6 |
| 40 | 0.2 +j .12 | 3.1 -j 9.4 |

 Z_{in} - Gate shunted with 25 Ω I_{DQ} = 100mA Z_{OL} - Conjugate of optimum load for 750 Watts output at V_{dd} = 250V

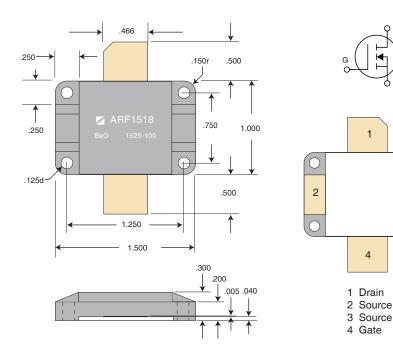
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Thermal Considerations and Package Mounting:

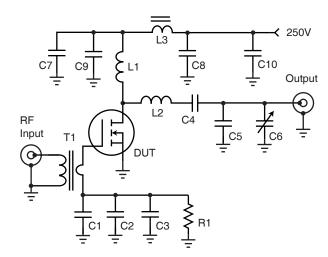
The rated 1350W power dissipation is only available when the package mounting surface is at 25°C and the junction temperature is 200°C. The thermal resistance between junctions and case mounting surface is 0.12°C/W. When installed, an additional thermal impedance of 0.1°C/W between the package base and the mounting surface is typical. Insure that the mounting surface is smooth and flat. Thermal joint compound must be used to reduce the effects of small surface irregularities. The heatsink should incorporate a copper heat spreader to obtain best results. Use 4-40 or M3 screws torqued to 1.2 Nm.

HAZARDOUS MATERIAL WARNING

The ceramic portion of the device between leads and mounting surface is beryllium oxide-BeO. Beryllium oxide dust is toxic when inhaled. Care must be taken during handling and mounting to avoid damage to this area These devices must never be thrown away with general industrial or domestic waste.



ARF1518 -- 13.56 MHz Test Circuit



C1-C3 1nF X7R 100V smt
C4 2x 8.2 nF 1kV COG
C5 270pF x2 ATC 100C
C7-C10 8.2 nF 1kv COG
C11 390 + 27 pF ATC 100C
L1 2uH - 22t #24 enam. .312" dia.
L2 368 nH - 5t #12 .625" dia .5" l
L3 500nH 2t on 850u .5" bead
R1 2.2k 0.5W
T1 10:1t transformer

Parts placement - Not to Scale.

